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Dual D-Type Positive Edge-Triggered Flip-Flop

RENESAS

ADE-205-361 (Z) 1st. Edition Sep. 2000

Description

The HD74AC74 is a dual D-type flip-flop with Asynchronous Clear and Set inputs and complementary (Q, \overline{Q}) outputs. Information at the input is transferred to the outputs on the positive edge of the clock pulse. Clock triggering occurs at a voltage level of the clock pulse and is not directly related to the transition time of the positive-going pulse. After the Clock Pulse input threshold voltage has been passed, the Data input is locked out and information present will not be transferred to the outputs until the next rising edge of the Clock Pulse input.

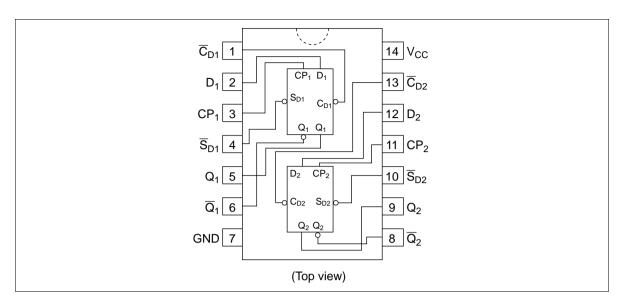
Features

Asynchronous Inputs:

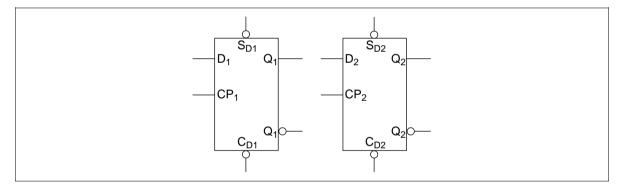
Low input to \overline{S}_D (Set) sets Q to High level Low input to \overline{C}_D (Clear) sets Q to Low level Clear and Set are independent of clock Simultaneous Low on \overline{C}_D and \overline{S}_D makes both Q and \overline{Q} High

• Outputs Source/Sink 24 mA

Pin Arrangement



Logic Symbol



Pin Names

D ₁ , D ₂	Data Inputs
CP_1, CP_2	Clock Pulse Inputs
$\overline{C}_{D1}, \overline{C}_{D2}$	Direct Clear Inputs
$\overline{\mathbf{S}}_{\mathrm{D1}}, \overline{\mathbf{S}}_{\mathrm{D2}}$	Direct Set Inputs
$\mathbf{Q}_1, \overline{\mathbf{Q}}_1, \mathbf{Q}_2, \overline{\mathbf{Q}}_2$	Outputs



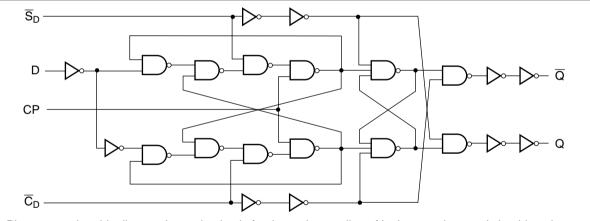
Truth Table (Each Half)

Inputs				Outputs		
$\overline{\bm{S}}_{\!\scriptscriptstyle D}$		$\overline{\mathbf{C}}_{D}$	СР	D	Q	Q
L		Н	Х	Х	Н	L
Н		L	Х	Х	L	Н
L		L	Х	Х	Н	Н
Н		Н		Н	Н	L
Н		Н		L	L	Н
Н		Н	L	Х	Q ₀	$\overline{Q}_{_0}$
Н	:	High Voltage Level				
L		Low Voltage Level				
v		Immotorial				

- X : Immaterial
- : Low-to-High Clock Transition

 $Q_0(\overline{Q}_0)$: Previous $Q(\overline{Q})$ before Low-to-High Transition of Clock

Logic Diagram



Please note that this diagram is provised only for the understanding of logic operations and should not be used to estimate propagation delays.

DC Characteristics (unless otherwise specified)

Item	Symbol	Max	Unit	Condition
Maximum quiescent supply current	I _{cc}	40	μA	$V_{IN} = V_{CC}$ or ground, $V_{CC} = 5.5 V$, Ta = Worst case
Maximum quiescent supply current	I _{cc}	4.0	μΑ	$V_{IN} = V_{CC}$ or ground, $V_{CC} = 5.5 \text{ V}$, Ta = 25°C



AC Characteristics

			Ta = +25°C C _∟ = 50 pF			Ta = −40°C to +85°C C _L = 50 pF		
Item	Symbol	V _{cc} (V)* ¹	Min	Тур	Max	Min	Max	Unit
Maximum clock	\mathbf{f}_{\max}	3.3	100	125	—	95	—	MHz
frequency		5.0	140	160	—	125	—	
Propagation delay	t _{PLH}	3.3	1.0	8.0	12.0	1.0	13.0	ns
$\overline{C}_{{}_{Dn}} \text{or} \overline{S}_{{}_{Dn}} \text{to} Q_{{}_{n}} \text{or} \overline{Q}_{{}_{n}}$		5.0	1.0	6.0	9.0	1.0	10.0	
Propagation delay	t _{PHL}	3.3	1.0	10.5	12.0	1.0	13.5	ns
$\overline{C}_{_{Dn}} \text{ or } \overline{S}_{_{Dn}} \text{ to } Q_{_{n}} \text{ or } \overline{Q}_{_{n}}$		5.0	1.0	8.0	9.5	1.0	10.5	
Propagation delay	t _{PLH}	3.3	1.0	8.0	13.5	1.0	16.0	ns
CP_n to Q_n or \overline{Q}_n		5.0	1.0	6.0	10.0	1.0	10.5	_
Propagation delay	t _{PHL}	3.3	1.0	8.0	14.0	1.0	14.5	ns
CP_n to Q_n or \overline{Q}_n		5.0	1.0	6.0	10.0	1.0	10.5	_

Note: 1. Voltage Range 3.3 is 3.3 V \pm 0.3 V Voltage Range 5.0 is 5.0 V \pm 0.5 V

AC Operating Requirements: HD74AC74

			Ta = +25°C C _∟ = 50 pF		Ta = −40°C to +85°C C _L = 50 pF	
Item	Symbol	V _{cc} (V)* ¹	Тур	Guaranteed	Minimum	Unit
Set-up time, HIGH or LOW	t _{su}	3.3	1.5	4.0	4.5	ns
D _n to CP _n		5.0	1.0	3.0	3.0	_
Hold time, HIGH or LOW	t _h	3.3	-2.0	0	0	ns
D _n to CP _n		5.0	-1.5	0	0	_
CP_n or \overline{C}_{Dn} or \overline{S}_{Dn}	t _w	3.3	3.0	5.5	7.0	ns
Pulse width		5.0	2.5	4.5	5.0	_
Recovery time	t _{rec}	3.3	-2.5	0	0	ns
\overline{C}_{Dn} or \overline{S}_{Dn} to CP		5.0	-2.0	0	0	_

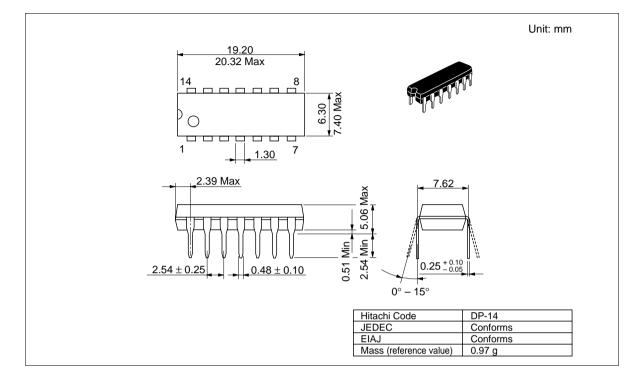
Note: 1. Voltage Range 3.3 is 3.3 V \pm 0.3 V Voltage Range 5.0 is 5.0 V \pm 0.5 V

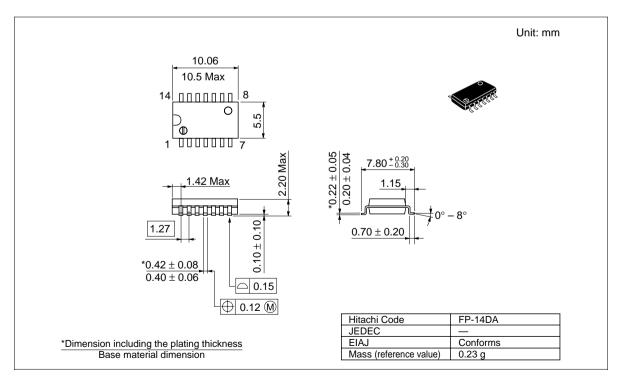


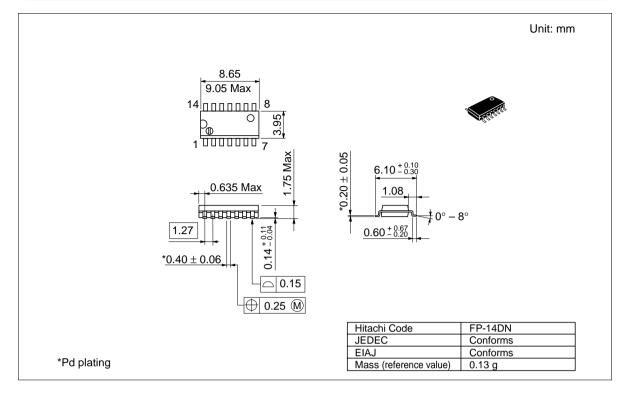
Capacitance

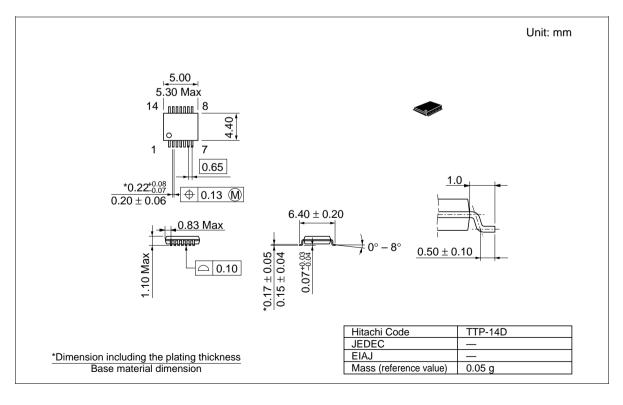
Item	Symbol	Тур	Unit	Condition
Input capacitance	CIN	4.5	pF	$V_{cc} = 5.5 V$
Power dissipation capacitance	C _{PD}	35.0	pF	$V_{cc} = 5.0 V$

Package Dimensions









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